

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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HZ1206C202R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

D 0.51 [.020] ± 0.25 [.010]

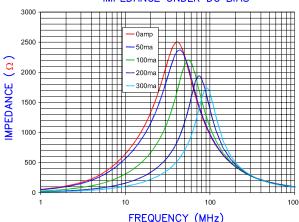
A B

ELECTRICAL CHARACTERISTICS:									
Z @ 30MF (<u>Ω</u>)	Ηz	DCR $\left(\begin{array}{c}\Omega\end{array} ight)$	Rated Current						
Nominal	2000								
Minimum	1500								
Maximum	2500	0.50	300 mA						

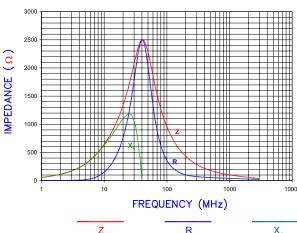
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C (INCLUDING SELF-HEATING)

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

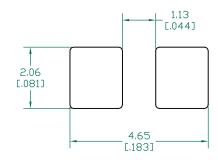


|Z| , R, AND X vs. FREQUENCY



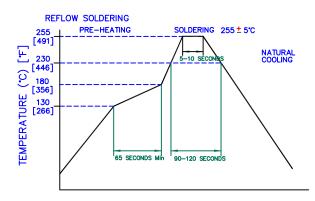
AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3228

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS





	DIMENSIONS ARE IN mm [INCHE	This print is the property of Laird	j						
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				rights to design or invention are reserved.					
				PROJECT/PART NUMBER:	REV	PART TYP	E:	DRAWN BY:	
C	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	Q	HZ1206C202R-10	С	CO-FIRE		ТМВ	
В	UPDATE COMPANY LOGO ADD ROHS	03/24/08	JRK	DATE: 04/03/04 SC	CALE: N	TS T	SHEET:		
Α	ORIGINAL DRAFT	04/03/04	тмв		DOL #		2	of 2	
REV	DESCRIPTION	DATE	INT	HZ1206C202R-10-C	,	-		· · ·	